



APT39F60J

600V, 42A, 0.11Ω Max t_{rr} ≤290ns

N-Channel FREDFET

Power MOS 8TM is a high speed, high voltage N-channel switch-mode power MOSFET. This 'FREDFET' version has a drain-source (body) diode that has been optimized for high reliability in ZVS phase shifted bridge and other circuits through reduced t_{rr} , soft recovery, and high recovery dv/dt capability. Low gate charge, high gain, and a greatly reduced ratio of C_{rss}/C_{iss} result in excellent noise immunity and low switching loss. The intrinsic gate resistance and capacitance of the poly-silicon gate structure help control di/dt during switching, resulting in low EMI and reliable paralleling, even when switching at very high frequency.

Sortop* VULRecognized* ISOTOP* VULRecognized* Tile # E145592 APT39F60J Single die FREDFET

FEATURES

- Fast switching with low EMI
- Low t_{rr} for high reliability
- Ultra low C_{rss} for improved noise immunity
- Low gate charge
- Avalanche energy rated
- RoHS compliant

TYPICAL APPLICATIONS

- ZVS phase shifted and other full bridge
- Half bridge
- PFC and other boost converter
- Buck converter
- Single and two switch forward
- Flyback

Absolute Maximum Ratings

| Symbol | Parameter | Ratings | Unit |
|-----------------|---|---------|------|
| I | Continuous Drain Current @ T _C = 25°C | 42 | |
| 'D | Continuous Drain Current @ T _C = 100°C | 26 | A |
| I _{DM} | Pulsed Drain Current $^{\textcircled{0}}$ | 210 | |
| V _{GS} | Gate-Source Voltage | ±30 | V |
| E _{AS} | Single Pulse Avalanche Energy $^{\oslash}$ | 1580 | mJ |
| I _{AR} | Avalanche Current, Repetitive or Non-Repetitive | 28 | А |

Thermal and Mechanical Characteristics

| Symbol | Characteristic | Min | Тур | Мах | Unit |
|----------------------------------|---|------|------|-----|--------|
| P _D | Total Power Dissipation @ $T_{C} = 25^{\circ}C$ | | | 480 | W |
| R _{θJC} | Junction to Case Thermal Resistance | | 0.26 | | °C/W |
| R _{ecs} | Case to Sink Thermal Resistance, Flat, Greased Surface | | 0.15 | | 0/11 |
| T _J ,T _{STG} | Operating and Storage Junction Temperature Range | -55 | | 150 | °C |
| V _{Isolation} | RMS Voltage (50-60hHz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.) | 2500 | | | V |
| W _T | Package Weight | | 1.03 | | oz |
| | | | 29.2 | | g |
| Torque | Transische and Maustine Oracus | | | 10 | in∙lbf |
| | Terminals and Mounting Screws. | | | 1.1 | N∙m |

Static Characteristics

$T_1 = 25^{\circ}C$ unless otherwise specified

APT39F60J

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|-----------------------------------|---|--|------------------------|-----|------|------|-------|
| Symbol | Parameter | Test Conditions | | Min | Тур | Max | Unit |
| V _{BR(DSS)} | Drain-Source Breakdown Voltage | $V_{GS} = 0V, I_{D} = 250 \mu A$ | | 600 | | | V |
| $\Delta V_{BR(DSS)} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | Reference to 25°C, $I_D = 250 \mu A$ | | | 0.57 | | V/°C |
| R _{DS(on)} | Drain-Source On Resistance ^③ | V _{GS} = 10V | , I _D = 28A | | 0.09 | 0.11 | Ω |
| V _{GS(th)} | Gate-Source Threshold Voltage | $\gamma = \gamma$ | L = 2.5m/ | 2.5 | 4 | 5 | V |
| $\Delta V_{GS(th)} / \Delta T_J$ | Threshold Voltage Temperature Coefficient | $V_{GS} = V_{DS}, I_D = 2.5 \text{mA}$ | | | -10 | | mV/°C |
| | Zero Gate Voltage Drain Current | V _{DS} = 600V | T _J = 25°C | | | 250 | |
| DSS | | V _{GS} = 0V | T _J = 125°C | | | 1000 | μA |
| I _{GSS} | Gate-Source Leakage Current | $V_{GS} = \pm 30V$ | | | | ±100 | nA |

Dynamic Characteristics

T_J = 25°C unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Тур | Мах | Unit |
|------------------------|--|---|-----|-------|-----|------|
| 9 _{fs} | Forward Transconductance | $V_{DS} = 50V, I_{D} = 28A$ | | 55 | | S |
| C _{iss} | Input Capacitance | | | 11300 | | |
| C _{rss} | Reverse Transfer Capacitance | V _{GS} = 0V, V _{DS} = 25V f = 1MHz | | 115 | | |
| C _{oss} | Output Capacitance | 1 111112 | | 1040 | | |
| C _{o(cr)} ④ | Effective Output Capacitance, Charge Related | $y_{1} = 0y_{1}y_{2} = 0y_{1} = 0y_{2}$ | | 550 | | pF |
| C _{o(er)} (5) | Effective Output Capacitance, Energy Related | V_{GS} = 0V, V_{DS} = 0V to 400V | | 285 | | |
| Q _g | Total Gate Charge | $y_{1} = 0 \pm 40 y_{1} + -000$ | | 280 | | nC |
| Q _{gs} | Gate-Source Charge | $V_{GS} = 0 \text{ to } 10V, I_{D} = 28A,$ $V_{DS} = 300V$ | | 60 | | |
| Q _{gd} | Gate-Drain Charge | v _{DS} - 300V | | 120 | | |
| t _{d(on)} | Turn-On Delay Time | Resistive Switching | | 65 | | |
| t _r | Current Rise Time | V _{DD} = 400V, I _D = 28A | | 75 | | ne |
| t _{d(off)} | Turn-Off Delay Time | R _G = 2.2Ω [®] , V _{GG} = 15V | | 190 | | ns |
| t _f | Current Fall Time | | | 60 | | |

Source-Drain Diode Characteristics

| Symbol | Parameter | Test Conditions | Min | Тур | Мах | Unit |
|-----------------|---|---|-----|------|-----|------|
| ۱ _s | Continuous Source Current (Body Diode) | MOSFET symbol showing the | | | 42 | А |
| I _{SM} | Pulsed Source Current (Body Diode) ^① | integral reverse p-n junction diode (body diode) | | | 210 | ~ |
| V _{SD} | Diode Forward Voltage | $I_{SD} = 28A, T_{J} = 25^{\circ}C, V_{GS} = 0V$ | | | 1.2 | V |
| t | | $T_{J} = 25^{\circ}C$ | | 255 | 290 | 20 |
| ۲r | t _{rr} Reverse Recovery Time | T _J = 125°C | | 450 | 540 | ns |
| Q _{rr} | Reverse Recovery Charge | $I_{SD} = 28A^{(3)}$ $T_J = 25^{\circ}C$ | | 1.41 | | |
| ∝ rr | | $di_{SD}/dt = 100A/\mu s$ $T_J = 125^{\circ}C$ | | 3.66 | μ μ | μC |
| 1 | Reverse Recovery Current | $V_{DD} = 100V$ $T_{J} = 25^{\circ}C$ | | 10.7 | | ٨ |
| rrm | | T _J = 125°C | | 15.8 | | A |
| dv/dt | Peak Recovery dv/dt | I _{SD} ≤ 28A, di/dt ≤1000A/µs, V _{DD} = 400V, T _J = 125°C | | | 20 | V/ns |

(1) Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

(2) Starting at $T_J = 25^{\circ}$ C, L = 4.03mH, $R_G = 25\Omega$, $I_{AS} = 28$ A.

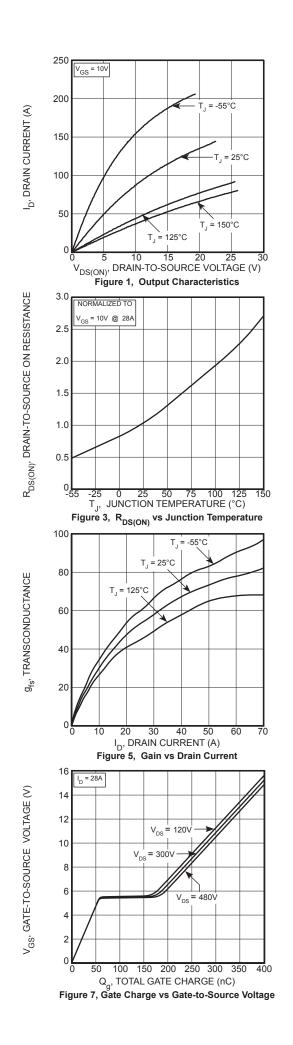
(3) Pulse test: Pulse Width < 380μ s, duty cycle < 2%.

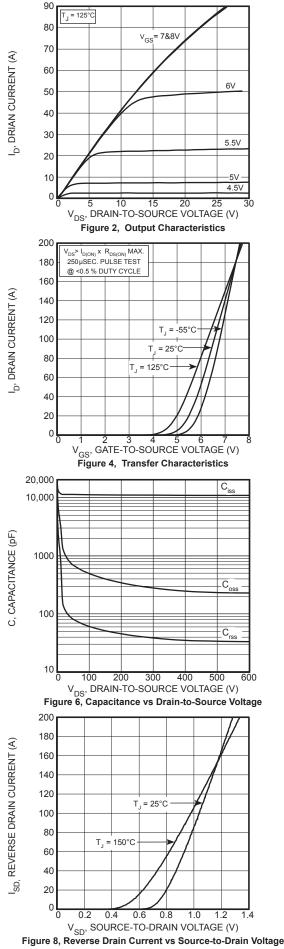
(4) C_{o(cr)} is defined as a fixed capacitance with the same stored charge as C_{OSS} with V_{DS} = 67% of V_{(BR)DSS}.
(5) C_{o(er)} is defined as a fixed capacitance with the same stored energy as C_{OSS} with V_{DS} = 67% of V_{(BR)DSS}. To calculate C_{o(er)} for any value of V_{DS} less than V_{(BR)DSS}, use this equation: C_{o(er)} = -1.10E-7/V_{DS}² + 4.60E-8/V_{DS} + 1.72E-10.

6 R_G is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

Microsemi reserves the right to change, without notice, the specifications and information contained herein.







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